



FINAL PRODUCT/PROCESS CHANGE NOTIFICATION

Generic Copy

20-Oct-2009

SUBJECT: ON Semiconductor Final Product/Process Change Notification #16340

TITLE: Ultra-Low Capacitance ESD Protection Devices: Max Ipp Datasheet Specification Change

PROPOSED FIRST SHIP DATE: 18-Jan-2010

AFFECTED CHANGE CATEGORY(S): Device Specification

AFFECTED PRODUCT DIVISION(S): Protection and Control

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or Lon Robinson < lon.robinson@onsemi.com >

SAMPLES: Contact your local ON Semiconductor Sales Office

ADDITIONAL RELIABILITY DATA: Available

Contact your local ON Semiconductor Sales Office

NOTIFICATION TYPE:

Final Product/Process Change Notification (FPCN)

Final change notification sent to customers. FPCNs are issued at least 90 days prior to implementation of the change.

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact your local ON Semiconductor Sales Office.

DESCRIPTION AND PURPOSE:

In an effort to ensure ON Semi's high quality standards are met, the Max Ipp specification for the Vcc to Gnd configuration will be changed to 12A for the devices included in this PCN.



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RELIABILITY DATA SUMMARY:

No reliability data. Datasheet change only.

ELECTRICAL CHARACTERISTIC SUMMARY:

Available upon request.



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AFFECTED DEVICE LIST

NUC2401MNTAG
NUP2114UCMR6T1G
NUP4114HMR6T1G
NUP4114UCW1T2G